



PMEG2005CT

20 V, 500 mA low VF dual Schottky barrier rectifier

8 October 2024

Product data sheet

1. General description

Planar Schottky barrier rectifier in common cathode configuration with an integrated guard ring for stress protection, encapsulated in a SOT23 small Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: $I_{F(AV)} \leq 0.5 \text{ A}$
- Reverse voltage: $V_R \leq 20 \text{ V}$
- Small SMD plastic package
- Low forward voltage

3. Applications

- Low voltage rectification
- Reverse polarity protection
- High efficiency DC-to-DC conversion
- High-speed switching
- Switch Mode Power Supply (SMPS)
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

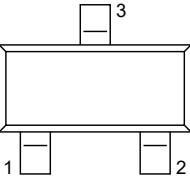
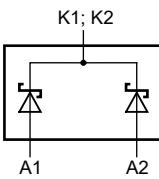
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
V_R	reverse voltage	$T_j = 25 \text{ }^\circ\text{C}$		-	-	20	V
$I_{F(AV)}$	average forward current	$\delta = 0.5; f = 20 \text{ kHz}; \text{square wave}; T_{amb} \leq 100 \text{ }^\circ\text{C}$	[1]	-	-	0.5	A
		$\delta = 0.5; f = 20 \text{ kHz}; \text{square wave}; T_{sp} \leq 130 \text{ }^\circ\text{C}$		-	-	0.5	A
V_F	forward voltage	$I_F = 0.5 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$		-	360	390	mV
I_R	reverse current	$V_R = 20 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$		-	30	200	μA

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode (diode 1)	 SOT23	 006aaa438
2	A	anode (diode 2)		
3	K1, K2	common cathode (diode 1 and diode 2)		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG2005CT	SOT23	plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	SOT23

7. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
PMEG2005CT	P8%

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V_R	reverse voltage	$T_j = 25^\circ\text{C}$		-	20	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$; $f = 20$ kHz; square wave; $T_{\text{amb}} \leq 100^\circ\text{C}$	[1]	-	0.5	A
		$\delta = 0.5$; $f = 20$ kHz; square wave; $T_{\text{sp}} \leq 130^\circ\text{C}$		-	0.5	A
I_{FPM}	repetitive peak forward current	$t_p \leq 1$ ms; $\delta \leq 0.25$		-	3.9	A
I_{FSM}	non-repetitive peak forward current	$t_p = 8$ μs ; square wave; $T_{j(\text{init})} = 25^\circ\text{C}$		-	10	A
Per device; one diode loaded						
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25^\circ\text{C}$	[2]	-	330	mW
			[3]	-	400	mW
			[1]	-	460	mW
T_j	junction temperature			-	150	$^\circ\text{C}$
T_{amb}	ambient temperature			-55	150	$^\circ\text{C}$
T_{stg}	storage temperature			-65	150	$^\circ\text{C}$

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1cm^2 .

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per device; one diode loaded							
$R_{\text{th}(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	375	K/W
			[1] [3]	-	-	310	K/W
			[1] [4]	-	-	270	K/W
$R_{\text{th}(j-sp)}$	thermal resistance from junction to solder point		[5]	-	-	60	K/W

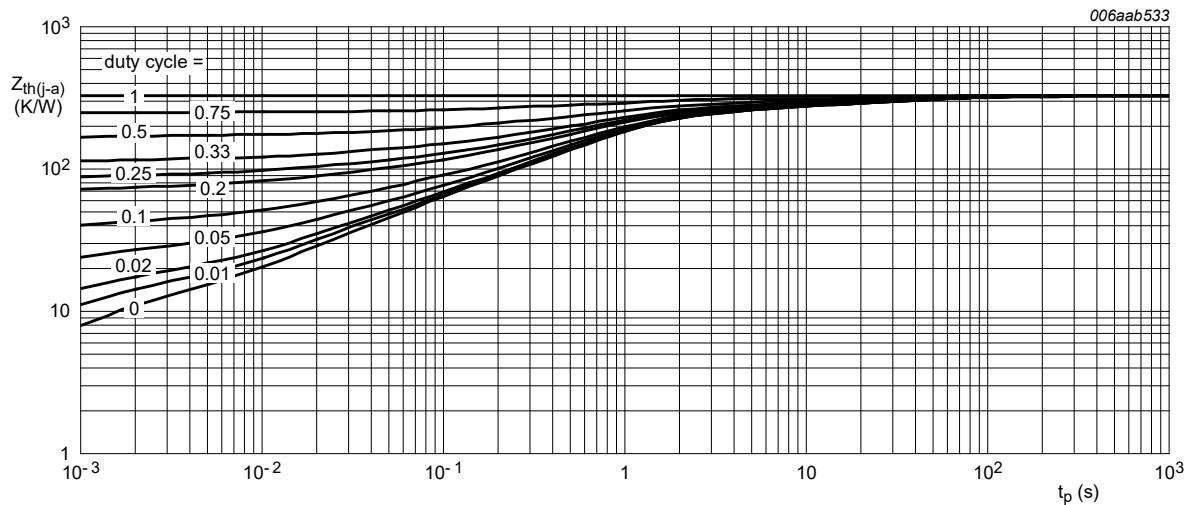
[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1cm^2 .

[4] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[5] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

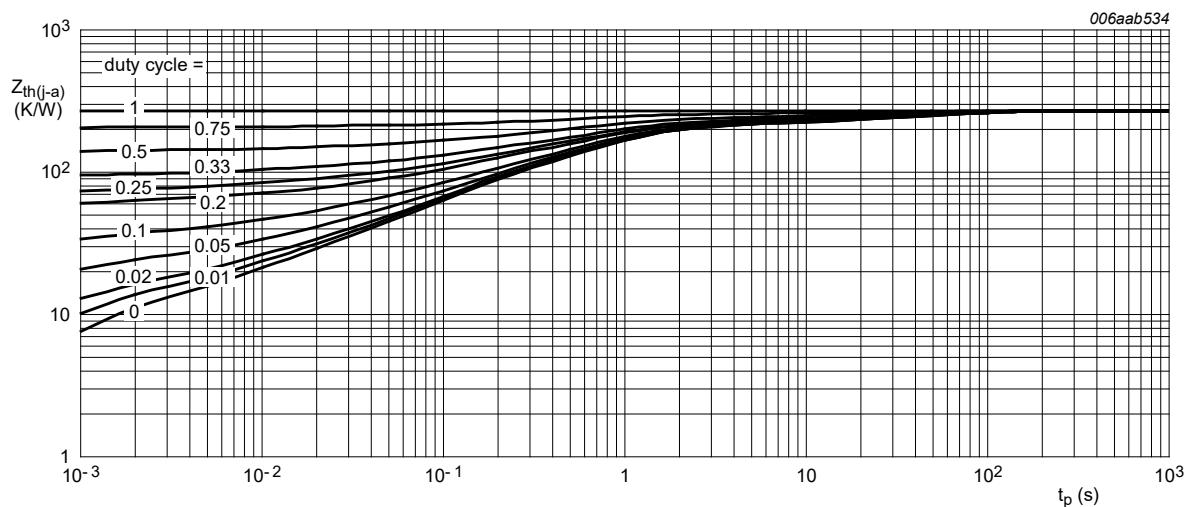
FR4 PCB, mounting pad for cathode 1 cm²

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

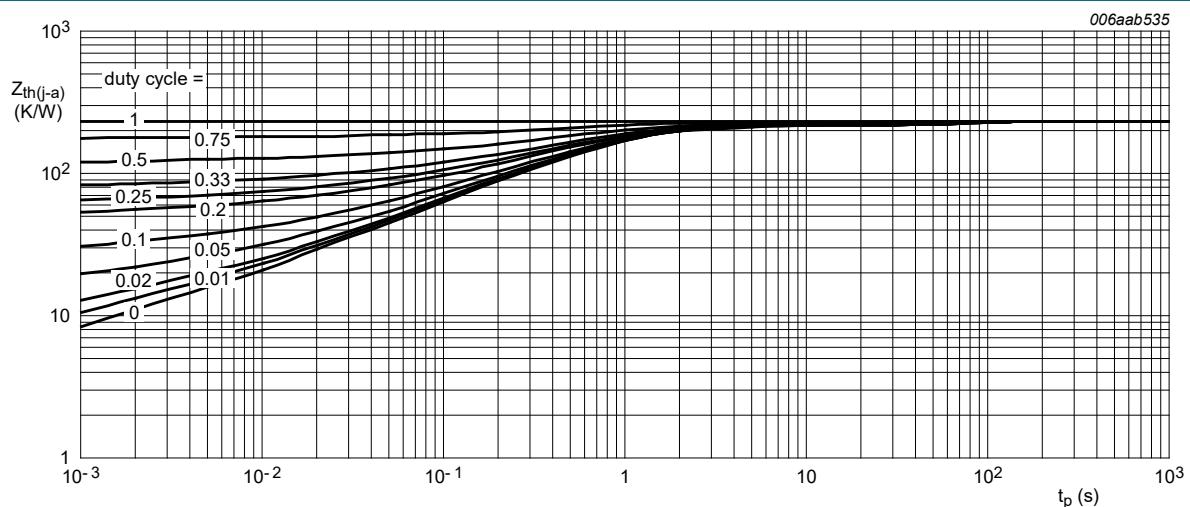
Ceramic PCB, Al₂O₃, standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
V _F	forward voltage	I _F = 0.1 mA; T _j = 25 °C I _F = 1 mA; T _j = 25 °C I _F = 10 mA; T _j = 25 °C I _F = 100 mA; T _j = 25 °C I _F = 0.5 A; T _j = 25 °C		-	95	130	mV
I _R	reverse current	V _R = 10 V; T _j = 25 °C V _R = 20 V; T _j = 25 °C		-	11	40	µA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C		-	66	80	pF
t _{rr}	reverse recovery time	When switched from I _F = 10 mA to I _R = 10 mA; R _L = 100 Ω; measured at I _R = 1 mA.		-	22	-	ns

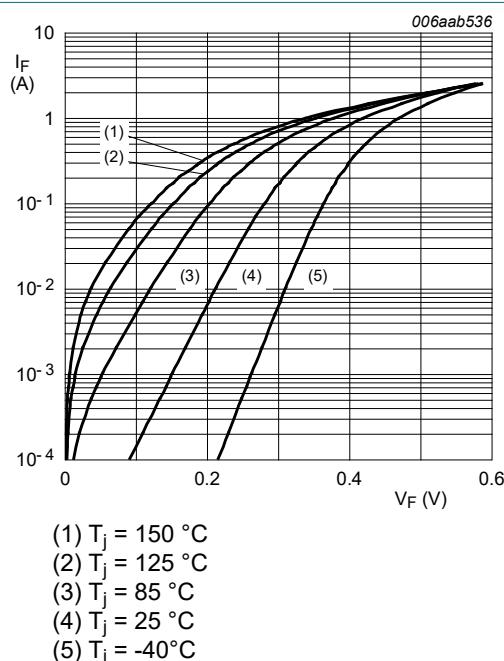


Fig. 4. Forward current as a function of forward voltage; typical values

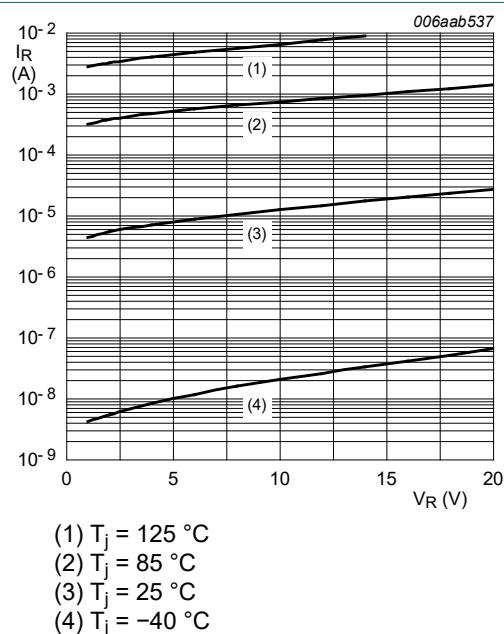
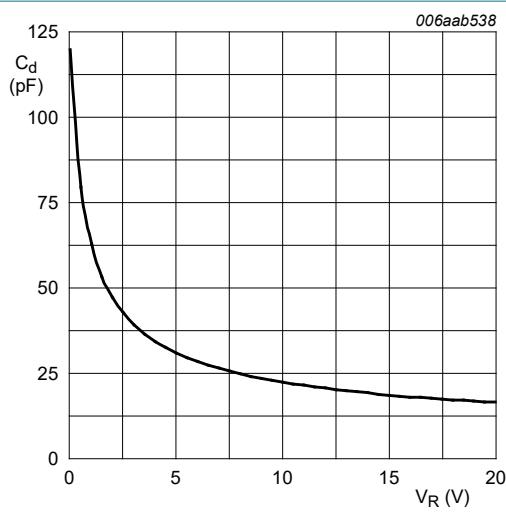
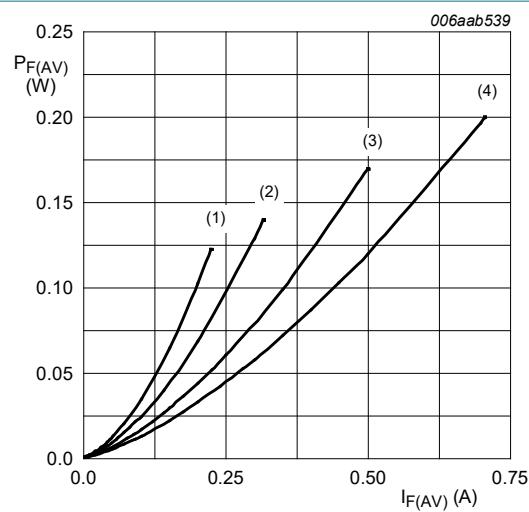


Fig. 5. Reverse current as a function of reverse voltage; typical values



$f = 1$ MHz; $T_{amb} = 25$ °C

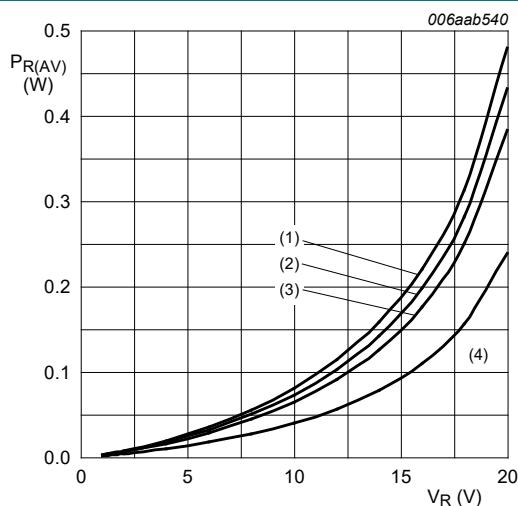
Fig. 6. Diode capacitance as a function of reverse voltage; typical values



$T_j = 150$ °C

- (1) $\delta = 0.1$
- (2) $\delta = 0.2$
- (3) $\delta = 0.5$
- (4) $\delta = 1$

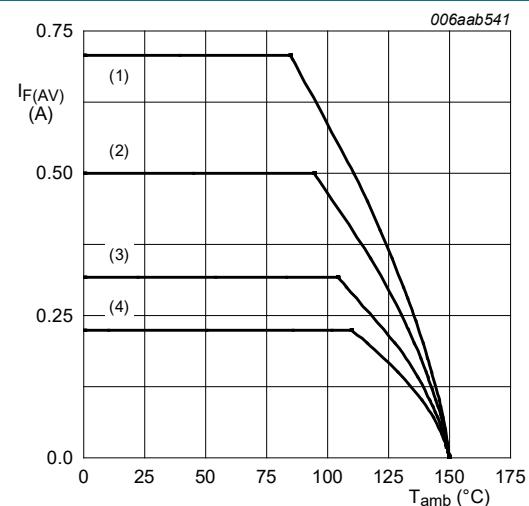
Fig. 7. Average forward power dissipation as a function of average forward current; typical values



$T_j = 125$ °C

- (1) $\delta = 1$
- (2) $\delta = 0.9$
- (3) $\delta = 0.8$
- (4) $\delta = 0.5$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values

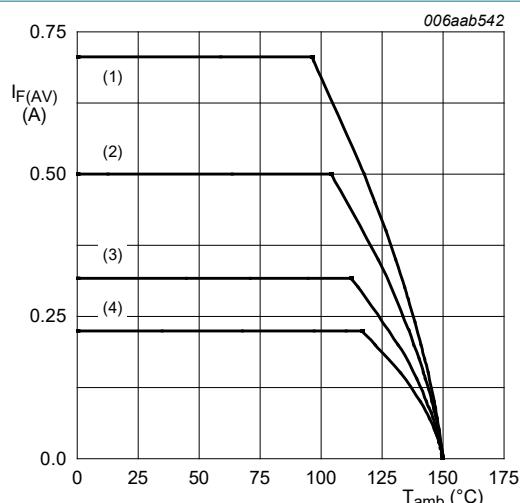


FR4 PCB, standard footprint

$T_j = 150$ °C

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; $f = 20$ kHz
- (3) $\delta = 0.2$; $f = 20$ kHz
- (4) $\delta = 0.1$; $f = 20$ kHz

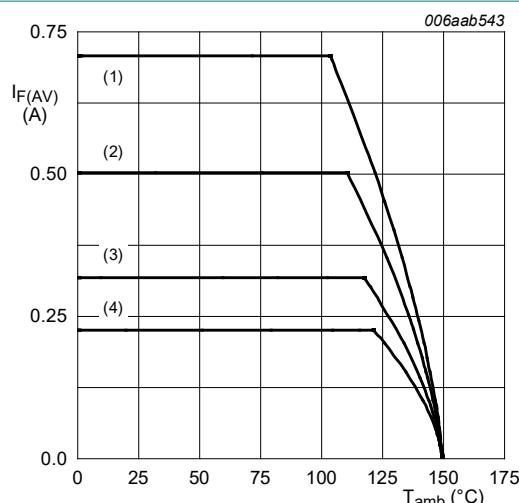
Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²
 $T_j = 150$ °C

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; f = 20 kHz
- (3) $\delta = 0.2$; f = 20 kHz
- (4) $\delta = 0.1$; f = 20 kHz

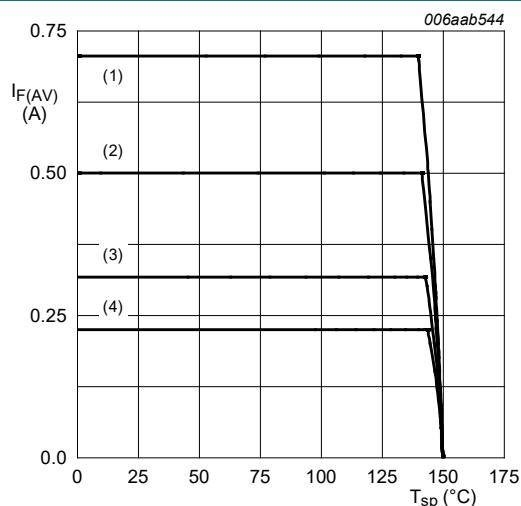
Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint
 $T_j = 150$ °C

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; f = 20 kHz
- (3) $\delta = 0.2$; f = 20 kHz
- (4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



$T_j = 150$ °C
(1) $\delta = 1$; DC
(2) $\delta = 0.5$; f = 20 kHz
(3) $\delta = 0.2$; f = 20 kHz
(4) $\delta = 0.1$; f = 20 kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

11. Test information

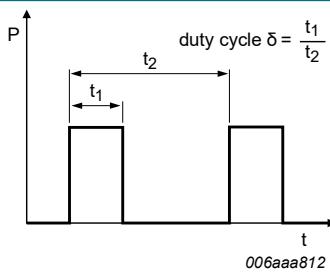
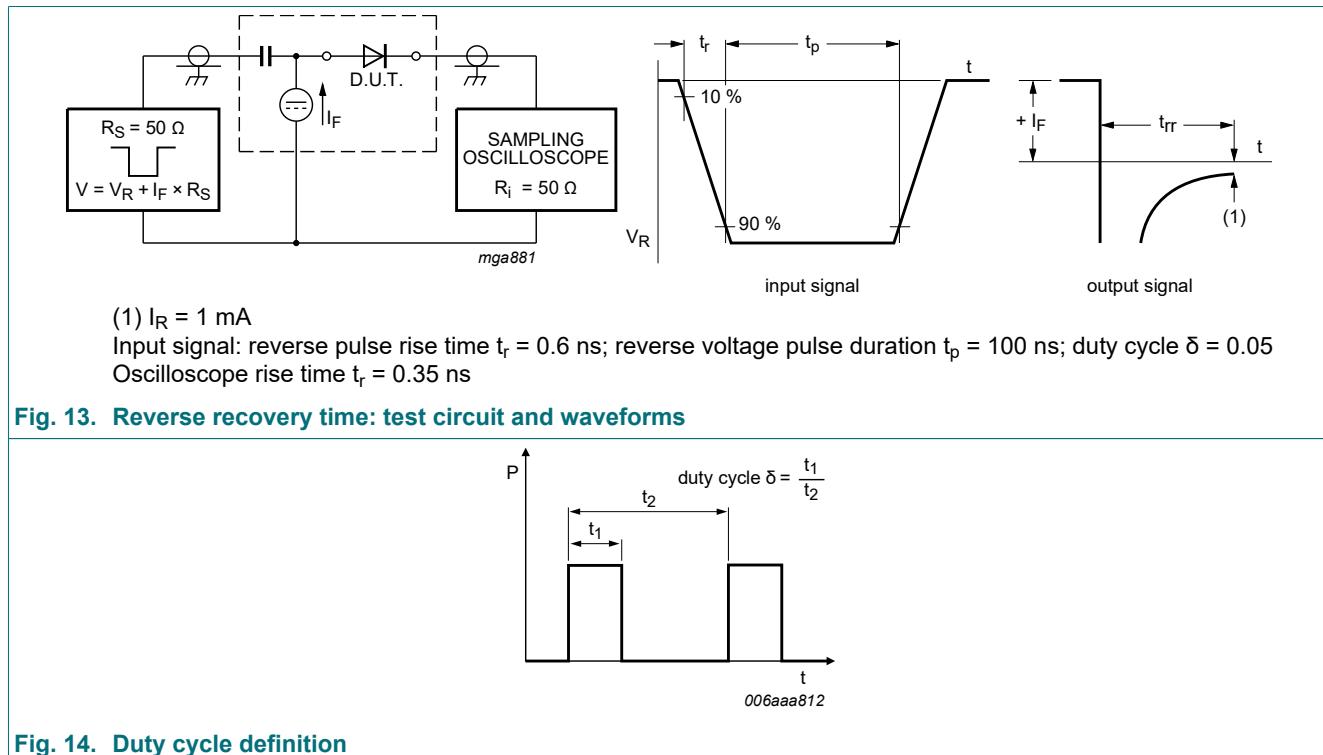


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta \text{ with } I_M \text{ defined as peak current}$$

$$I_{RMS} = I_{F(AV)} \text{ at DC}$$

$$I_{RMS} = I_M \times \sqrt{\delta} \text{ with } I_{RMS} \text{ defined as RMS current}$$

12. Package outline

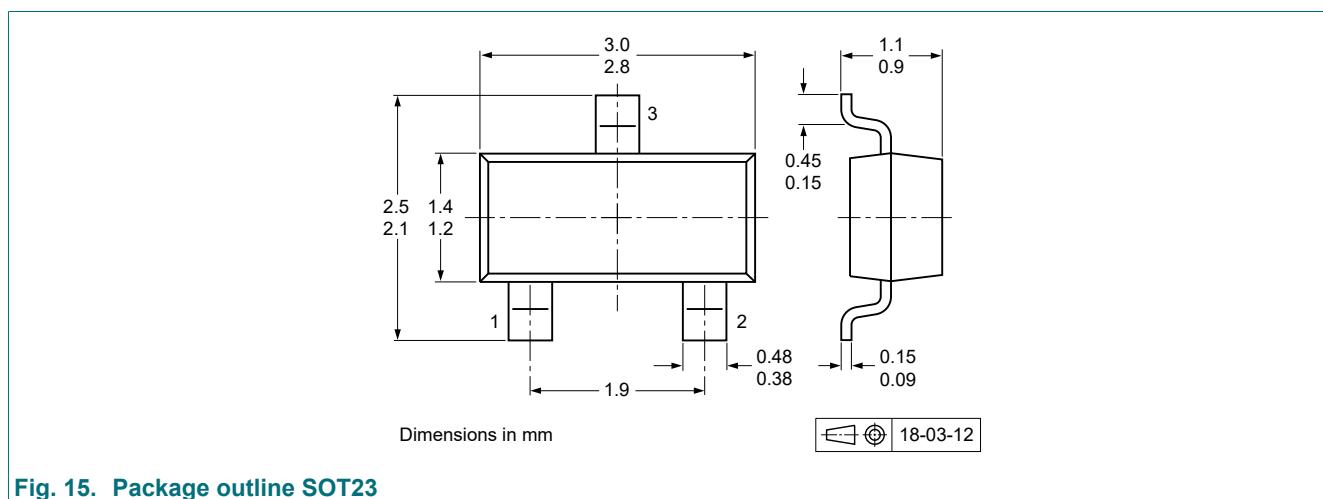


Fig. 15. Package outline SOT23

13. Soldering

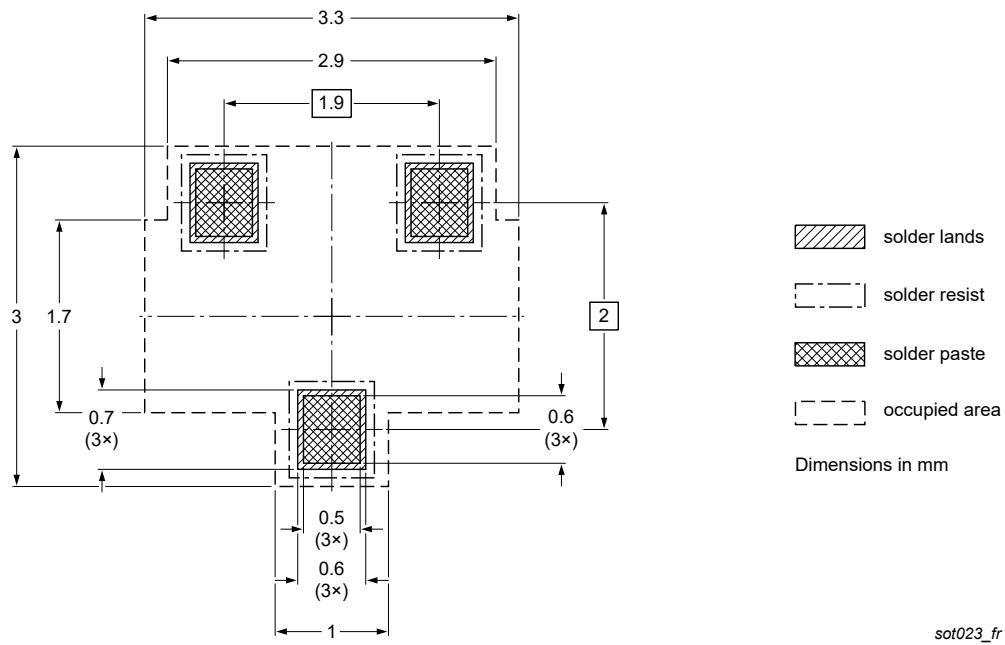


Fig. 16. Reflow soldering footprint for SOT23

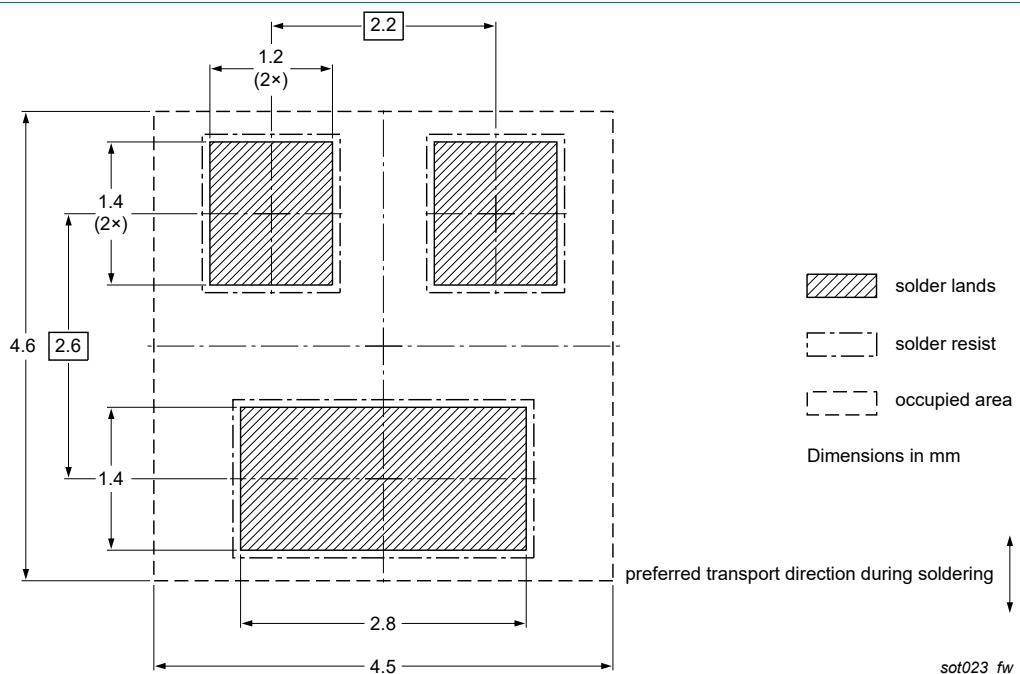


Fig. 17. Wave soldering footprint for SOT23

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG2005CT v.4	20241008	Product data sheet	-	PMEG2005CT v.3
Modifications:	<ul style="list-style-type: none">Product(s) changed to non-automotive qualification. Please refer to nexperia.com for automotive (-Q) product alternative(s).			
PMEG2005CT v.3	20230626	Product data sheet	-	PMEG2005CT v.2
PMEG2005CT v.2	20100622	Product data sheet	-	PMEG2005CT_1
PMEG2005CT_1	20090604	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Contents

1. General description.....	1
2. Features and benefits.....	1
3. Applications.....	1
4. Quick reference data.....	1
5. Pinning information.....	2
6. Ordering information.....	2
7. Marking.....	2
8. Limiting values.....	3
9. Thermal characteristics.....	3
10. Characteristics.....	5
11. Test information.....	8
12. Package outline.....	8
13. Soldering.....	9
14. Revision history.....	10
15. Legal information.....	11

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